Onsemi

Low-Voltage SPDT Analog Switch or 2:1 Multiplexer / **De-multiplexer Bus Switch**

NC7SB3157, FSA3157

Description

The NC7SB3157 / FSA3157 is a high-performance, single-pole / double-throw (SPDT) analog switch or 2:1 multiplexer / de-multiplexer bus switch.

The device is fabricated with advanced sub-micron CMOS technology to achieve high-speed enable and disable times and low on resistance. The break-before-make select circuitry prevents disruption of signals on the B Port due to both switches temporarily being enabled during select pin switching. The device is specified to operate over the 1.65 to 5.5 V V_{CC} operating range. The control input tolerates voltages up to 5.5 V, independent of the V_{CC} operating range.

Features

- Useful in Both Analog and Digital Applications
- Space-Saving, SC70 6-Lead Surface Mount Package
- Ultra-Small, MicroPak[™] Leadless Package
- Low On Resistance: $< 10 \Omega$ on Typical at 3.3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Rail-to-Rail Signal Handling
- Power-Down, High-Impedance Control Input
- Over-Voltage Tolerance of Control Input to 7.0 V
- Break-Before-Make Enable Circuitry
- 250 MHz, 3 dB Bandwidth
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

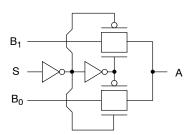
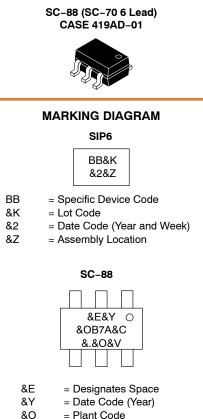


Figure 1. Logic Symbol





SIP6 CASE 127EB

= Plant Code

- = Specific Device Code
- = Die Run Code
- = Pin 1 Dot
- &V = Date (Week)

B7A

&C

&.

ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

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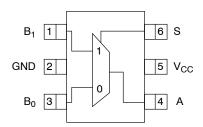


Figure 2. Pin Assignments SC70

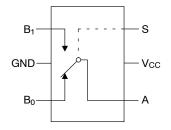


Figure 3. Analog Symbol

FUNCTION TABLE

Input (S)	Function
Logic Level Low	B ₀ Connected to A
Logic Level High	B ₁ Connected to A

PIN DESCRIPTIONS

Pin Names	Description
A, B ₀ , B ₁	Data Ports
S	Control Input

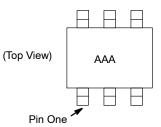


Figure 4. Pin One Orientation

NOTE: Orientation of top mark determines pin one location. Read the top product code mark left to right and pin one is the lower left pin (see Figure 4).

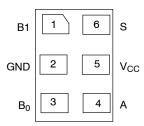


Figure 5. Pad Assignments for MicroPak

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	+7.0	V
VS	DC Switch Voltage (Note 1)	-0.5	V _{CC} +0.5	V
V _{IN}	DC Input Voltage (Note 1)	-0.5	+7.0	V
Ι _{ΙΚ}	DC Input Diode Current at V _{IN} < 0 V	-	-50	mA
I _{OUT}	DC Output Current	-	128	mA
I _{CC} /I _{GND}	DC V _{CC} or Ground Current	-	±100	mA
T _{STG}	Storage Temperature Range	-65	+150	°C
TJ	Junction Temperature Under Bias	-	+150	°C
ΤL	Junction Lead Temperature (Soldering, 10 seconds)	-	+260	°C
MSL	Moisture Sensitivity Level (JEDEC J-STD-020A)	-	1	Level
PD	Power Dissipation at +85°C	-	180	mW
ESD	Human Body Model, JESD22-A114	-	4000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

Symbol		Parameter				
V _{CC}	Supply Voltage Operating	Supply Voltage Operating				
V _{IN}	Control Input Voltage (Note 2	Control Input Voltage (Note 2)				
V _{IN}	Switch Input Voltage (Note 2)				V _{CC}	V
V _{OUT}	Output Voltage (Note 2)				V _{CC}	V
T _A	Operating Temperature			-40	+85	°C
f _{r,} t _f	Input Rise and Fall Time	Control Input V _{CC} = $2.3 \text{ V} - 3.6 \text{ V}$		0	10	ns/V
		Control Input V _{CC} = $4.5 \text{ V} - 5.5 \text{ V}$		0	5	ns/V
θ_{JA}	Thermal Resistance, SC70				270	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

2. Control input must be held HIGH or LOW; it must not float.

DC ELECTRICAL CHARACTERISTICS

				T _A = +25°C			T _A = −40°C to +85°C			
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Min.	Max.	Unit	
V _{IH}	High Level Input Voltage		1.65–1.95	0.75 V _{CC}	-	-	0.75 V _{CC}	-	V	
			2.3–5.5	$0.7 V_{CC}$	-	-	$0.7 V_{CC}$	-	V	
V _{IL}	Low Level Input Voltage		1.65–1.95	-	-	0.25 V _{CC}	_	0.25 V _{CC}	V	
			2.3–5.5	-	-	$0.3 V_{CC}$	-	$0.3 V_{CC}$	V	
I _{IN}	Input Leakage Current	$0 \leq V_{IN} \leq 5.5 \ V$	0–5.5	-	±0.05	±0.1	-	±1	μA	
I _{OFF}	Off State Leakage Current	$0 \leq A, \ B \leq V_{CC}$	1.65–5.5	-	±0.05	±0.1	-	±1	μA	
R _{ON}	Switch On Resistance	$V_{IN} = 0 V$, $I_O = 30 mA$	4.5	-	3.0	7.0	-	7.0	Ω	
	(Note 3)	V_{IN} = 2.4 V, I_O = -30 mA	4.5	-	5.0	12.0	-	12.0		
		V_{IN} = 4.5 V, I_O = -30 mA	4.5	-	7.0	15.0	-	15.0	-	
		$V_{IN} = 0 V, I_{O} = 24 mA$	3.0	-	4.0	9.0	-	9.0		
		V_{IN} = 3 V, I_O = -24 mA	3.0	-	10.0	20.0	-	20.0		
		V _{IN} = 0 V, I _O = 8 mA	2.3	-	5.0	12.0	-	12.0		
		V_{IN} = 2.3 V, I_O = -8 mA	2.3	-	13.0	30.0	-	30.0		
		$V_{IN} = 0 V$, $I_O = 4 mA$	1.65	-	6.5	20.0	-	20.0		
		V _{IN} = 1.65 V, I _O = -4 mA	1.65	-	17.0	50.0	-	50.0		
I _{CC}	Quiescent Supply Current; All Channels On or Off	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$	5.5	-	-	1	-	10	μA	
	Analog Signal Range		V _{CC}	0	-	V _{CC}	0	V _{CC}	V	
R _{RANGE}	On Resistance Over	$I_A = -30 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$	4.5	-	-	-	-	25.0	Ω	
	Signal Range (Note 3, 7)	$I_{A} = -24 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$	3.0	-	-	-	-	50.0		
		$I_A = -8 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC}$	2.3	-	-	-	-	100		
		$I_A = -4 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC}$	1.65	-	-	-	-	300		
ΔR_{ON}	On Resistance Match	I _A = -30 mA, V _{Bn} = 3.15	4.5	-	0.15	-	-	-	Ω	
	Between–Channels (Note 3, 4, 5)	I _A = -24 mA, V _{Bn} 2.1	3.0	-	0.2	-	-	-		
		I _A = -8 mA, V _{Bn} = 1.6	2.3	-	0.5	-	-	-		
		I _A = -4 mA, V _{Bn} = 1.15	1.65	-	0.50	_	-	-		
R _{flat}	On Resistance Flatness	$I_A = -30 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC}$	5.0	-	6.0	-	-	-	Ω	
	(Note 3, 4, 6)	$I_A = -24 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$	3.3	-	12.0	_	-	-		
		$I_A = -8 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC}$	2.5	-	28.0	-	-	-		
		$I_A = -4 \text{ mA}, 0 \le V_{Bn} \le V_{CC}$	1.8	-	125	-	-	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower

of the voltages on the two (A or B Ports).

4. Parameter is characterized, but not tested in production.

5. $\Delta R_{ON} = R_{ON} \max - R_{ON} \min$ minimum measured at identical V_{CC}, temperature, and voltage levels.

6. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions. 7. Guaranteed by design.

AC ELECTRICAL CHARACTERISTICS

				T _A = +25°C			T _A = -40°C to +85°C			Figure	
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Min.	Max.	Unit	Number	
t _{PHL} ,	Propagation Delay	V _I = OPEN	1.65–1.95	-	-	3.5	-	3.5	ns	Figure 12	
t _{PLH}	Bus-to-Bus (Note 8)			2.3–2.7	-	-	1.2	-	1.2		Figure 13
			3.0–3.6	-	-	0.8	-	0.8			
			4.5–5.5	-	-	0.3	-	0.3			
t _{PZL} ,	Output Enable Time	$V_I = 2 \times V_{CC}$ for t_{PZL}	1.65–1.95	7.0	-	23.0	7.0	24.0	ns	Figure 12	
t _{PZH}	Turn–On Time (A to B _n)	$V_{I} = 0 V$ for t_{PZH}	2.3–2.7	3.5	-	13.0	3.5	14.0		Figure 13	
			3.0–3.6	2.5	-	6.9	2.5	7.6			
			4.5–5.5	1.7	-	5.2	1.7	5.7			
t _{PHZ} Tu	Output Disable Time Turn-Off Time (A Port to B Port)		1.65–1.95	3.0	-	12.5	3.0	13.0	ns	Figure 12 Figure 13	
			2.3–2.7	2.0	-	7.0	2.0	7.5			
			3.0–3.6	1.5	-	5.0	1.5	5.3			
			4.5–5.5	0.8	-	3.5	0.8	3.8			
t _{B-M}	Break-Before-Make			1.65–1.95	0.5	-	-	0.5	-	ns	Figure 14
	Time (Note 9)		2.3–2.7	0.5	-	-	0.5	-			
			3.0–3.6	0.5	-	-	0.5	-			
			4.5–5.5	0.5	-	-	0.5	-			
Q	Charge Injection (Note 9)	C _L = 0.1 nF, V _{GEN} = 0 V	5.0	-	7.0	-	-	-	рС	Figure 15	
		R _{GEN} = 0 Ω	3.3		3.0						
OIRR	Off Isolation (Note 10)	R_L = 50 Ω , f = 10 MHz	1.65–5.5	-	-57.0	-	-	-	dB	Figure 16	
Xtalk	Crosstalk	R_L = 50 Ω , f = 10 MHz	1.65–5.5	-	-54.0	-	-	-	dB	Figure 17	
BW	-3dB Bandwidth	R _L = 50 Ω	1.65–5.5	-	250	-	-	-	MHz	Figure 20	
THD	Total Harmonic Distortion (Note 9)	R_L = 600 Ω, 0.5 V _{PP} , f = 600 Hz to 20 KHz	5.0	-	.011	-	-	-	%	-	

8. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the on resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

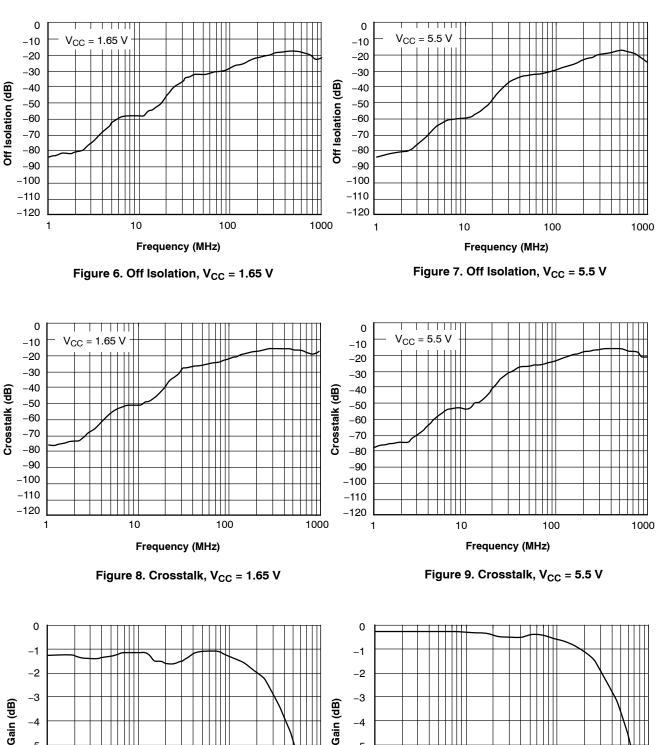
9. Guaranteed by design.

10. Off Isolation = 20 $\log_{10} [V_A / V_{Bn}]$.

CAPATICANCE ($T_A = 25^{\circ}C$, f = 1 MHz Capacitance is characterized, but not tested in production.)

Symbol	Parameter	Conditions	Тур.	Max.	Unit	Figure Number
C _{IN}	Control Pin Input Capacitance	$V_{CC} = 0 V$	2.3	-	pF	-
C _{IO-B}	B Port Off Capacitance	$V_{CC} = 5.0 V$	6.5	-	pF	Figure 18
C _{IOA-ON}	A Port Capacitance When Switch Is Enabled	V_{CC} = 5.0 V	18.5	-	pF	Figure 19

TYPICAL PERFORMANCE CHARACTERISTICS

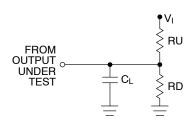


Gain (dB) -4 -4 -5 -5 -6 -6 $C_L = 0 pF$ $C_L = 0 pF$ -7 -7 V_{CC} = 1.65 V $V_{CC} = 5.5 V$ -8 -8 1 10 100 1000 1 10 100 1000 Frequency (MHz) Frequency (MHz)

Figure 10. Bandwidth, V_{CC} = 1.65 V

Figure 11. Bandwidth, V_{CC} = 5.5 V

AC LOADING AND WAVEFORMS



NOTE: Input driven by 50 Ω source terminated in 50 Ω CL includes load and stray capacitance Input PRR = 1.0 MHz, t_w = 500 ns.



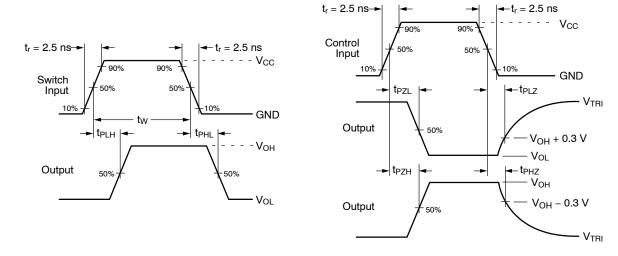
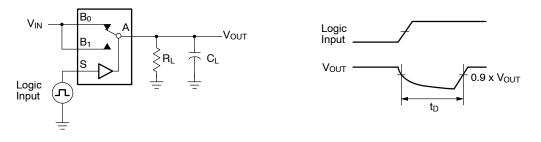
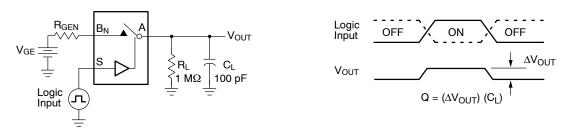


Figure 13. AC Waveforms





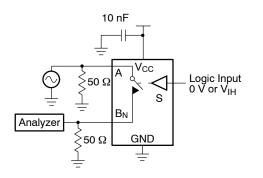


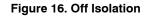


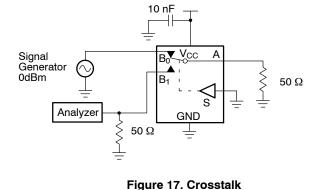
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AC LOADING AND WAVEFORMS (Continued)







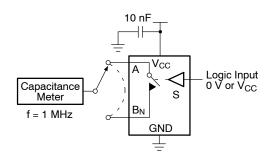


Figure 18. Channel Off Capacitance

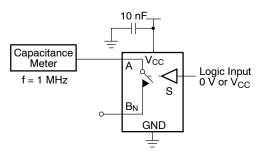
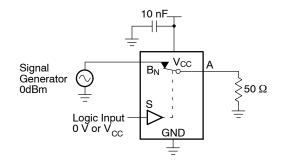
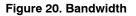


Figure 19. Channel On Capacitance





ORDERING INFORMATION

Part Number	Top Mark	Eco Status	Package Description	Shipping [†]
NC7SB3157P6X	B7A	RoHS	6-Lead, SC70, EIAJ SC88, 1.25 mm Wide Package	3000 / Tape and Reel
NC7SB3157L6X	BB	RoHS	6-Lead, MicroPak 1.0 mm Wide Package	5000 / Tape and Reel
FSA3157P6X	B7A	RoHS	6-Lead, SC70, EIAJ SC88, 1.25 mm Wide Package	3000 / Tape and Reel
FSA3157L6X	BB	RoHS	6-Lead, MicroPak 1.0 mm Wide Package	5000 / Tape and Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

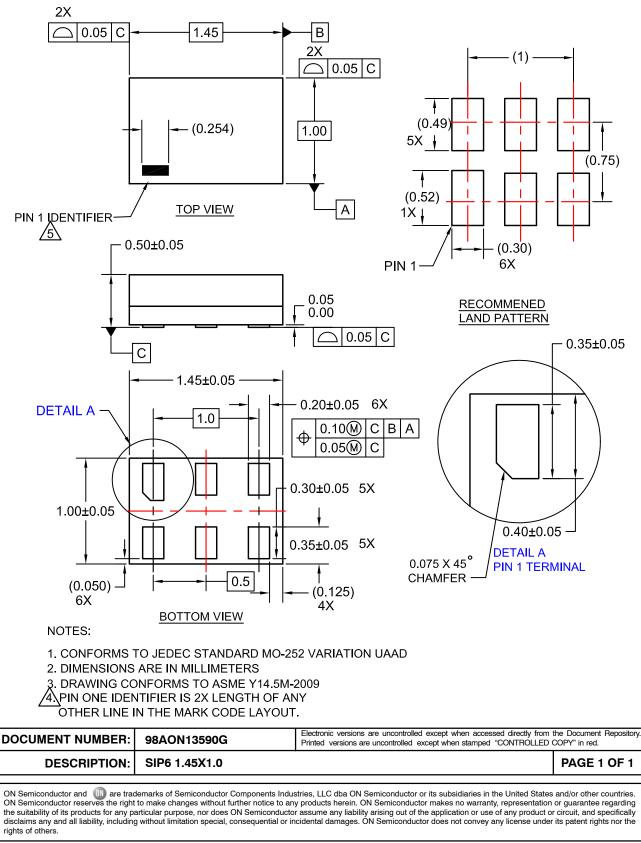
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SIP6 1.45X1.0 CASE 127EB ISSUE O

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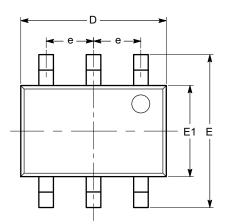


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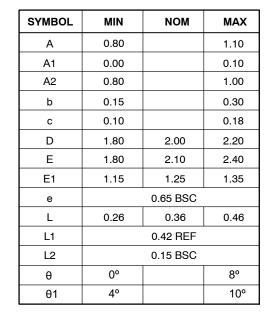


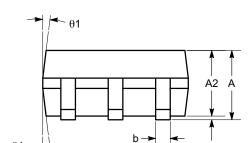
SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD-01 ISSUE A

DATE 07 JUL 2010









Notes:

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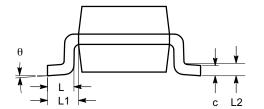
(1) All dimensions are in millimeters. Angles in degrees.

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(2) Complies with JEDEC MO-203.

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